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PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2720354

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TAKAMI SAWAGUCHI	12/24/2013

RECEIVING PARTY DATA

Name:	TOKYO PARTS INDUSTRIAL CO., LTD.	
Street Address:	236 HINODE-CHO, ISESAKI-SHI	
City:	GUNMA-KEN	
State/Country:	JAPAN	
Postal Code:	372-0022	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14041233

CORRESPONDENCE DATA

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Address Line 4: NEW YORK, NEW YORK 10168

ATTORNEY DOCKET NUMBER:	F-11184
NAME OF SUBMITTER:	/FRANK J. JORDAN/
Signature:	/Frank J. Jordan/
Date:	02/10/2014

Total Attachments: 1

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PATENT REEL: 032184 FRAME: 0191 F-11184

ASSIGNMENT

For value received, I, Takami SAWAGUCHI, an individual, with post office address at

c/o Tokyo Parts Industrial Co., Ltd., 236 Hinode-cho, Iscsaki-shi, Gunma-ken, 372-0022,

Japan, hereinafter assignor, hereby sell, assign and transfer to Tokyo Parts Industrial Co., Ltd.,

a corporation existing under the laws of Japan, located at 236 Hinode-cho, Isesaki-shi,

Gunma-ken, 372-0022, Japan, hereinafter assignee, and said assignee's successors, assigns, and

legal representatives the entire right, title, and interest, for all countries including the United States

of America, in and to certain inventions relating to HAPTIC SOLENOID described in an

application for Letters Patent of the United States, filed on September 30, 2013, and having

application serial number 14/041,233, and all patents which may be granted therefor, and all

divisions, reissues, continuations and extensions thereof, and authorize and request the

Commissioner of Patents and Trademarks to issue all patents on said improvements or resulting

therefrom to said assignee as assignee of the entire interest, and covenant that said assignor has full

right so to do, and agree that said assignor will communicate to said assignee or said assignee's

representatives any facts known to said assignor respecting said improvements and testify in any

legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications,

make all rightful oaths and generally do everything possible to aid said assignee, and said assignee's

successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the

United States.

Signature Takami Sawayucki Date Dec, 24, 20/3